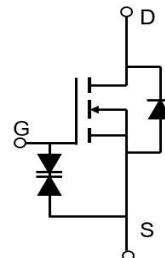


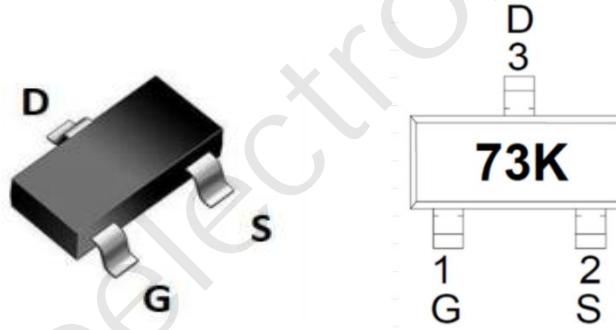
### Description

### Features

- 60V, 0.3A
- $R_{DS(ON)}$  Typ = 1.8Ω @  $V_{GS}$  = 10V
- $R_{DS(ON)}$  Typ = 2.5Ω @  $V_{GS}$  = 4.5V
- Advanced Trench Technology
- Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free
- ESD Protected: 2KV



Schematic Diagram



Marking and Pin Assignment

### Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTL2N7003K	73K	SOT-23	TAPING	7"	3000	120000

### Absolute Maximum Ratings (@ $T_J$ = 25°C unless otherwise specified)

Symbol	Parameter	Value	Units	
$V_{DS}$	Drain-to-Source Voltage	60	V	
$V_{GS}$	Gate-to-Source Voltage	±20	V	
$I_D$	Continuous Drain Current	0.3	A	
	$T_A = 25^\circ\text{C}$	0.3	A	
	$T_A = 100^\circ\text{C}$	0.18	A	
$I_{DM}$	Pulsed Drain Current <sup>(1)</sup>	1.2	A	
$P_D$	Power Dissipation	$T_A = 25^\circ\text{C}$	0.35	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>	357	°C/W	
$T_J, T_{STG}$	Junction & Storage Temperature Range	-55 to 150	°C	

**Electrical Characteristics ( $T_J = 25^\circ\text{C}$  unless otherwise specified)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	60	-	-	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 60\text{V}, V_{GS} = 0\text{V}$	-	-	1.0	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$	-	-	$\pm 800$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.6	2.2	V
$R_{\text{DS(ON)}}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 10\text{V}, I_D = 0.3\text{A}$	-	1.8	2.2	$\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 0.2\text{A}$	-	2.5	3	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance		-	18	-	pF
$C_{\text{oss}}$	Output Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	-	3.3	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	2	-	pF
$Q_g$	Total Gate Charge		-	1.7	-	nC
$Q_{gs}$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10\text{V}$	-	0.3	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$V_{DS} = 10\text{V}, I_D = 0.3\text{A}$	-	0.6	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On DelayTime		-	2	-	ns
$t_r$	Turn-On Rise Time	$V_{GS} = 10\text{V}, V_{DD} = 10\text{V}$	-	15	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_D = 0.2\text{A}, R_{\text{GEN}} = 10\Omega$	-	7	-	ns
$t_f$	Turn-Off Fall Time		-	20	-	ns
<b>Drain-Source Diode Characteristics and Max Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current		-	-	0.3	A
$I_{\text{SM}}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	1.2	A
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = 0.3\text{A}$	-	-	1.2	V

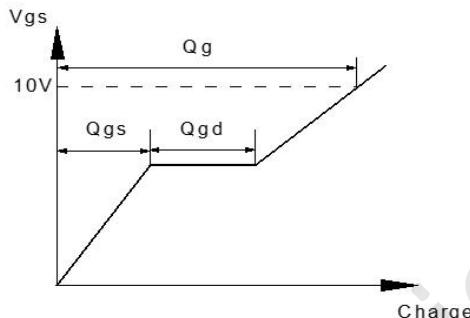
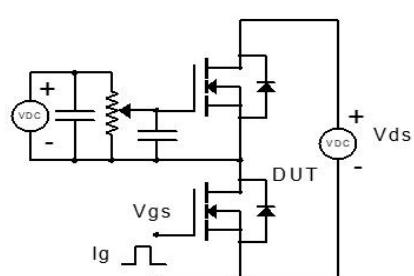
Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

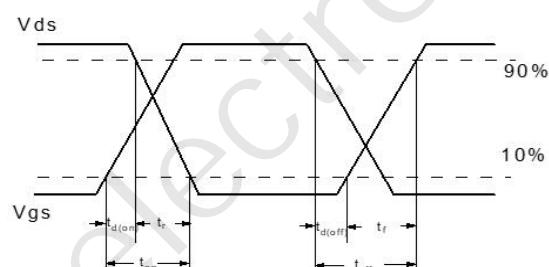
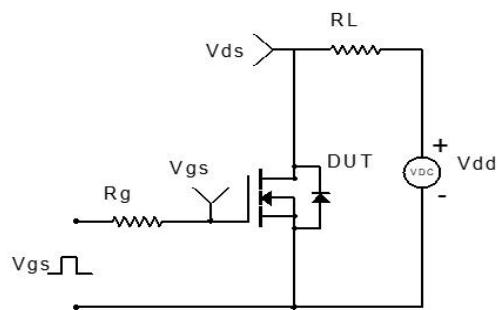
2.  $R_{\theta JA}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 0.5\%$ .

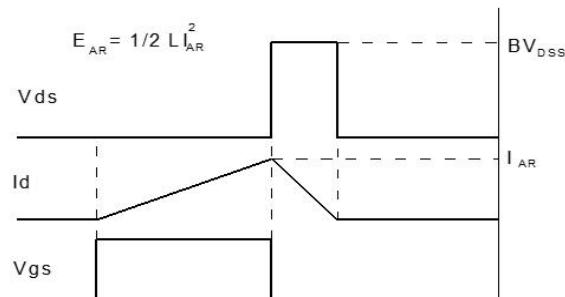
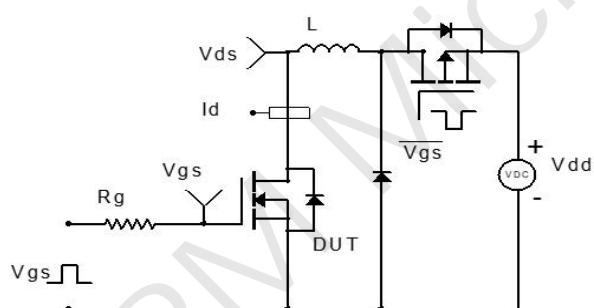
## Test Circuit



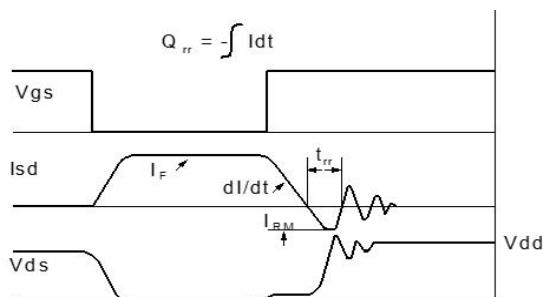
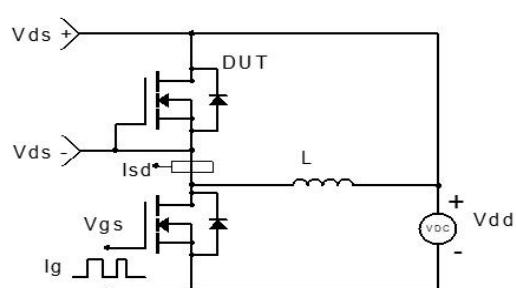
**Figure 1: Gate Charge Test Circuit & Waveform**



**Figure 2: Resistive Switching Test Circuit & Waveform**

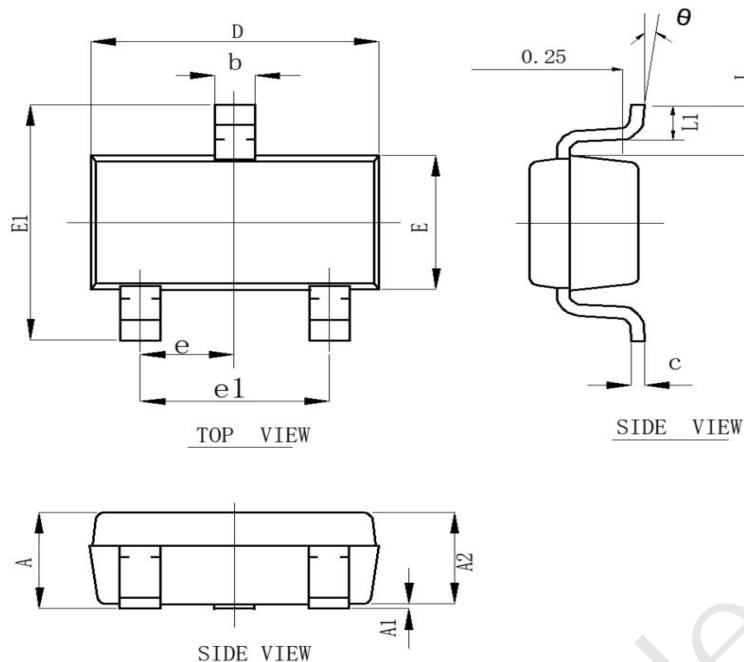


**Figure 3: Unclamped Inductive Switching Test Circuit & Waveform**



**Figure 4: Diode Recovery Test Circuit & Waveform**

## Package Mechanical Data(SOT-23)



COMMON DIMENSIONS In Millimeters		
SYMBOL	MIN	MAX
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
L	0.550 REF.	
θ	0°	8°
L1	0.300	0.500
e	0.950 TYP.	
e1	1.800	2.000

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